L Number	Hits	Search Text	DB	Time stamp
1	892		USPAT;	2003/12/23 11:15
		ultrapure) near3 (water)) and (water with	US-PGPUB;	
		(low near2 (resistance or resistivity)))	EPO; JPO;	
			DERWENT;	
			IBM TDB	
2	140	((wash\$3 or clean\$3 or spray\$3 or pure or	USPAT;	2003/12/23 11:28
	i	ultrapure) near3 (water)) same (water with	US-PGPUB;	
		(low near2 (resistance or resistivity)))	EPO; JPO;	
			DERWENT;	
			IBM TDB	
3	9	((wash\$3 or clean\$3) with (pure or	USPAT;	2003/12/23 11:29
		ultrapure) near3 (water)) same (water with	US-PGPUB;	
		(low near2 (resistance or resistivity)))	EPO; JPO;	
			DERWENT;	1
			IBM TDB	
4	240	((wash\$3 or clean\$3) with (pure or	USPAT;	2003/12/23 11:30
		ultrapure) near3 (water)) same (water	US-PGPUB;	
		near3 ((resistance or resistivity)))	EPO; JPO;	
		•	DERWENT;	
			IBM TDB	
5	23	((wash\$3 or clean\$3) with (pure or	USPAT;	2003/12/23 11:30
		ultrapure) near3 (water)) same (water	US-PGPUB;	
		near3 ((resistance or resistivity))) same	EPO; JPO;	
		(dust or static)	DERWENT;	
			IBM TDB	
-	204		USPĀT;	2003/12/22 15:22
		((coat\$3 or surfactant or dip or dipped or	US-PGPUB;	
		dipping or immers\$4 or submer\$5 or	EPO; JPO;	
		deposit\$3 or film or layer) with ((wafer	DERWENT;	
		or chip or substrate or disc or disk)	IBM TDB	1
	i	near3 (storage or storing or case or box	_	
		or holder or holding or housing or		
		carrier)))		
-	177		USPAT;	2003/12/22 15:05
		((coat\$3 or surfactant or dip or dipped or	US-PGPUB;	
		dipping or immers\$4 or submer\$5 or	EPO; JPO;	
		deposit\$3 or film or layer) with ((wafer	DERWENT;	
		or chip or substrate or disc or disk)	IBM TDB	
		near3 (storage or storing or case or box	_	
		or holding or housing or carrier)))		
-	2	(Munakata.in. or (Shin adj Etsu).as.) and	USPAT;	2003/12/22 14:55
		((coat\$3 or dip or dipped or dipping or	US-PGPUB;	
		immers\$4 or submer\$5 or deposit\$3 or film	EPO; JPO;	
		or layer) with ((wafer or chip or	DERWENT;	
		substrate or disc or disk) near3 (storage	IBM TDB	
		or storing or case or box or holding or	_	1
	1	housing or carrier)) with surfactant)		
-	40	(Munakata.in. or (Shin adj Etsu).as.) and	USPAT;	2003/12/22 14:56
İ		((coat\$3 or surfactant or dip or dipped or	US-PGPUB;	
		dipping or immers\$4 or submer\$5 or	EPO; JPO;	
		deposit\$3 or film or layer) with ((wafer	DERWENT;	
ĺ	1	or chip or substrate or disc or disk)	IBM_TDB	
1		near3 (storage or storing or case or box		
1		or holding or housing or carrier))) same		
ĺ		(dust\$3 or particle or particulate or		
		contamin\$8)		

((Munakata.in. or (Shin adj Etsu).as.) and ((coat\$3 or surfactant or dip or dipped or dipping or immers\$4 or submer\$5 or deposit\$3 or film or layer) with ((wafer or chip or substrate or disc or disk) near3 (storage or storing or case or box or holding or housing or carrier)) same (dust\$3 or particle or particulate or contamin\$8) not ((Munakata.in. or (Shin adj Etsu).as.) and ((coat\$3 or dip or dipped or dipping or immers\$4 or submer\$5 or deposit\$3 or film or layer) with ((wafer or chip or substrate or disc or dipping or immers\$4 or submer\$5 or deposit\$3 or film or layer) with ((wafer or chip or substrate or disc or dipping or immers\$4 or submer\$5 or deposit\$3 or film or layer) with ((wafer or chip or substrate or disc or dipping or immers\$4 or submer\$5 or deposit\$3 or film or layer) with ((wafer or chip or substrate or disc or disk) near3 (storage or storing or case or box or holding or housing or carrier))) not ((Munakata.in. or (Shin adj Etsu).as.) and ((coat\$3 or surfactant or dip or dipped or dipping or immers\$4 or submer\$5 or deposit\$3 or film or layer) with ((wafer or chip or substrate or disc or disk) near3 (storage or storing or case or box or holding or housing or carrier))) same (dust\$3 or particle or particulate or contamin\$8))  12 (Munakata.in. or (Shin adj Etsu).as.) and ((coat\$3 or surfactant or dip or dipped or dipping or immers\$4 or submer\$5 or chip or substrate or disc or disk) near3 (storage or storing or case or box or holding or housing or carrier))) same (dust\$3 or particle or particulate or contamin\$8))	
(dust\$3 or particle or particulate or contamin\$8)) not ((Munakata.in. or (Shin adj Etsu).as.) and ((coat\$3 or dip or dipped or dipping or immers\$4 or submer\$5 or deposit\$3 or film or layer) with ((wafer or chip or substrate or disc or disk) near3 (storage or storing or case or box or holding or housing or carrier))  137 ((Munakata.in. or (Shin adj Etsu).as.) and ((coat\$3 or surfactant or dip or dipped or dipping or immers\$4 or submer\$5 or deposit\$3 or film or layer) with ((wafer or chip or substrate or disc or disk) near3 (storage or storing or case or box or holding or housing or carrier))) not ((Munakata.in. or (Shin adj Etsu).as.) and ((coat\$3 or surfactant or dip or dipped or dipping or immers\$4 or submer\$5 or deposit\$3 or film or layer) with ((wafer or chip or substrate or disc or disk) near3 (storage or storing or case or box or holding or housing or carrier)) same (dust\$3 or particle or particulate or contamin\$8))  12 (Munakata.in. or (Shin adj Etsu).as.) and ((coat\$3 or surfactant or dip or dipped or dipping or immers\$4 or submer\$5 (DERWENT; DERWENT;	:00
((coat\$3 or surfactant or dip or dipped or dipping or immers\$4 or submer\$5 or deposit\$3 or film or layer) with ((wafer or chip or substrate or disc or disk) near3 (storage or storing or case or box or holding or housing or carrier))) not ((Munakata.in. or (Shin adj Etsu).as.) and ((coat\$3 or surfactant or dip or dipped or dipping or immers\$4 or submer\$5 or deposit\$3 or film or layer) with ((wafer or chip or substrate or disc or disk) near3 (storage or storing or case or box or holding or housing or carrier))) same (dust\$3 or particle or particulate or contamin\$8))  (Munakata.in. or (Shin adj Etsu).as.) and ((coat\$3 or surfactant or dip or dipped or dipping or immers\$4 or submer\$5 or Depoint or Coat\$3 or surfactant or dip or dipped or dipping or immers\$4 or submer\$5 or Depoint or De	:00
((coat\$3 or surfactant or dip or dipped or US-PGPUB; dipping or immers\$4 or submer\$5 or	
deposit\$3 or film or layer) with ((wafer or chip or substrate or disc or disk) IBM_TDB near3 (cassette))	:07
((Munakata.in. or (Shin adj Etsu).as.) and ((coat\$3 or surfactant or dip or dipped or dipping or immers\$4 or submer\$5 or deposit\$3 or film or layer) with ((wafer or Surfactant or dip or dipping or immers\$4 or submer\$5 or deposit\$3 or substrate or disc or disk) near3 (cassette))) not (((Munakata.in. or (Shin adj Etsu).as.) and ((coat\$3 or surfactant or dip or dipped or dipping or immers\$4 or submer\$5 or deposit\$3 or film or layer) with ((wafer or chip or substrate or disc or disk) near3 (storage or storing or case or box or holding or housing or carrier))) not ((Munakata.in. or (Shin adj Etsu).as.) and ((coat\$3 or surfactant or dip or dipped or dipping or immers\$4 or submer\$5 or deposit\$3 or film or layer) with ((wafer or chip or substrate or disc or disk) near3 (storage or storing or case or box or holding or housing or carrier))) same (dust\$3 or	06
particle or particulate or contamin\$8))) (Munakata.in. or (Shin adj Etsu).as.) and ((coat\$	08
896 (427/230,235).CCLS. USPAT; 2003/12/22 15:0	28
- 806 (427/352,353,354).CCLS. US-PGPUB USPAT; 2003/12/22 15:0	98
- 3616 (427/372.2,379,384).CCLS. US-PGPUB USPAT; 2003/12/22 15:0 US-PGPUB	)8

-	1369	(427/430.1).CCLS.	USPAT;	2003/12/22 15:09
-	717	(438/125).CCLS.	US-PGPUB USPAT;	2003/12/22 15:09
_	2870	(206/308.1,524.1,524.6,525,526,832).CCLS.	US-PGPUB USPAT;	2003/12/22 15:09
-	517	(206/524.3).CCLs.	US-PGPUB USPAT;	2003/12/22 15:09
-	10391	((427/352,353,354).CCLS.)	US-PGPUB USPAT; US-PGPUB	2003/12/22 15:14
-	16	((427/352,353,354).CCLS.) ((427/372.2,379,384).CCLS.) ((427/430.1).CCLS.) ((206/308.1,524.1,524.6,525,526,832).CCLS.) ((206/524.3).CCLS.)) and ((wafer or	USPAT; US-PGPUB	2003/12/22 15:12
-	0	((206/524.3).CCLS.) and ((wafer or	USPAT;	2003/12/22 15:11
-	40	semiconductor) same (surfactant)) ((206/524.3).CCLS.) and ((surfactant))	US-PGPUB USPAT;	2003/12/22 15:12
-	0	(((206/524.3).CCLS.) and ((surfactant))) and (wafer or semiconductor)	US-PGPUB USPAT;	2003/12/22 15:12
-	402	(((427/230,235).CCLS.) ((427/352,353,354).CCLS.)	US-PGPUB USPAT; US-PGPUB	2003/12/22 15:14
-		((427/430.1).CCLS.) ((438/125).CCLS.) ((206/308.1,524.1,524.6,525,526,832).CCLS.) ((206/524.3).CCLS.)) and ((coat\$3 or deposit\$3 or film or layer or immers\$5 or soak\$3 or dip or dipped or dipping or submer\$8) with surfactant) ((((427/230,235).CCLS.) ((427/332.2,337,384).CCLS.) ((427/372.2,379,384).CCLS.) ((427/372.2,379,384).CCLS.) ((206/308.1,524.1,524.6,525,526,832).CCLS.) ((206/524.3).CCLS.)) and ((coat\$3 or deposit\$3 or film or layer or immers\$5 or soak\$3 or dip or dipped or dipping or submer\$8) with surfactant)) and (dust\$3 or particle or particulate or contamin\$8) (((1427/230,235).CCLS.)	USPAT; US-PGPUB	2003/12/22 15:15
		((427/352,353,354).CCLS.) ((427/372.2,379,384).CCLS.) ((427/430.1).CCLS.) ((438/125).CCLS.) ((206/308.1,524.1,524.6,525,526,832).CCLS.) ((206/524.3).CCLS.)) and ((coat\$3 or deposit\$3 or film or layer or immers\$5 or soak\$3 or dip or dipped or dipping or submer\$8) with surfactant)) and (dust\$3 or contamin\$8)	USPAT; US-PGPUB	2003/12/22 15:15
		((427/352, 353, 354).CCLS.) ((427/372.2, 379, 384).CCLS.) ((427/430.1).CCLS.) ((438/125).CCLS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/22 15:20

-	7	((206/524.3).CCLS.) and (((wafer or chip	USPAT;	2003/12/22 15:21
	1	or substrate or disc or disk) near3	US-PGPUB;	
		(storage or storing or case or box or	EPO; JPO;	
		holder or holding or housing or carrier or cassette or transport\$6)))	DERWENT;	
-	439	(((427/230,235).CCLS.)	IBM_TDB USPAT;	2002/10/00 15 51
		((427/352,353,354).CCLS.)	US-PGPUB	2003/12/22 15:51
		((427/372.2,379,384).CCLS.)	OB TOLOR	
		((427/430.1).CCLS.) ((438/125).CCLS.)		
		((206/308.1,524.1,524.6,525,526,832).CCLS.)		
	1	((206/524.3).CCLS.)) and ((coat\$3 or		
	İ	surfactant or dip or dipped or dipping or		
İ		immers\$4 or submer\$5 or deposit\$3 or film		}
		or layer) with ((wafer or chip or		1
	i	substrate or disc or disk) near3 (storage		
		or storing or case or box or holder or holding or housing or carrier)))		
_	71	((((427/230,235).CCLS.)	tionam.	0000/10/00 15 04
	'-	((427/352,353,354).CCLS.)	USPAT; US-PGPUB	2003/12/22 15:24
	į	((427/372.2,379,384).CCLS.)	US-FGFUB	
		((427/430.1).CCLS.) ((438/125).CCLS.)		
		((206/308.1,524.1,524.6,525,526,832).CCLS.)		
	}	((206/524.3).CCLS.)) and ((coat\$3 or		
		surfactant or dip or dipped or dipping or		
		immers\$4 or submer\$5 or deposit\$3 or film		
		or layer) with ((wafer or chip or		
		substrate or disc or disk) near3 (storage		
		or storing or case or box or holder or		
		holding or housing or carrier))) ) and ((prevent\$5 or eliminat\$5 or reduc\$6 or		
		lower\$3 or stop\$4) near3 (dust\$3 or		
		particle or particulate or contamin\$8))		
-	255	(((427/230,235).CCLS.)	USPAT;	2003/12/22 15:35
		((427/352,353,354).CCLS.)	US-PGPUB	2003/12/22 13:33
l		((427/372.2,379,384).CCLS.)		
		((427/430.1).CCLS.) ((438/125).CCLS.)		
		((206/308.1,524.1,524.6,525,526,832).CCLS.)		
		((206/524.3).CCLS.)) and ((coat\$3 or		
1		surfactant or dip or dipped or dipping or		
		immers\$4 or submer\$5 or deposit\$3 or film or layer) with ((wafer or chip or		
		substrate or disc or disk) near2 (storage		l i
		or storing or box or holder or holding or		
		housing or carrier or cartridge)))		
-	211	((((427/230,235).CCLS.)	USPAT:	2003/12/22 15:29
1		((427/352,353,354).CCLS.)	US-PGPUB	
1		((427/372.2,379,384).CCLS.)		
1		((427/430.1).CCLS.) ((438/125).CCLS.)		
		((206/308.1,524.1,524.6,525,526,832).CCLS.)		
		((206/524.3).CCLS.)) and ((coat\$3 or surfactant or dip or dipped or dipping or	İ	
	ļ	immers\$4 or submer\$5 or deposit\$3 or film		]
		or layer) with ((wafer or chip or		ĺ
1		substrate or disc or disk) near2 (storage		
		or storing or box or holder or holding or	ĺ	
		housing or carrier or cartridge)))) not		
		(((((427/230,235).CCLS.)		į
		((427/352, 353, 354).CCLS.)		
	ļ	((427/372.2,379,384).CCLS.)		
		((427/430.1).CCLS.) ((438/125).CCLS.)		
		((206/308.1,524.1,524.6,525,526,832).CCLS.) ((206/524.3).CCLS.)) and ((coat\$3 or		1
]		surfactant or dip or dipped or dipping or		
		immers\$4 or submer\$5 or deposit\$3 or film		
]	i	or layer) with ((wafer or chip or		
		substrate or disc or disk) near3 (storage		1
		or storing or case or box or holder or		
	ļ	holding or housing or carrier)))) and	1	
	İ	((prevent\$5 or eliminat\$5 or reduc\$6 or		
	I	lower\$3 or stop\$4) near3 (dust\$3 or	J	
L		particle or particulate or contamin\$8)))		

-	129	(surfactant or scourol) and (((wafer or	EPO; JPO;	2003/12/22 15:48
		chip or substrate or disc or disk) near2	DERWENT;	
1		(storage or storing or box or holder or	IBM_TDB	
	İ	holding or housing or carrier or cartridge		
1	96	or case)))		
-	90	((surfactant or scourol) and (((wafer or	EPO; JPO;	2003/12/22 15:38
i		chip or substrate or disc or disk) near2	DERWENT;	
		(storage or storing or box or holder or	IBM_TDB	
		holding or housing or carrier or cartridge		
		or case))) ) and (coat\$3 or wash\$3 or	1	
		clean\$3 or film or layer or deposit\$3 or		
		immers\$5 or submer\$6 or soak\$3 or dip or dipped or dipping)		
-	33	((surfactant or scourol) and (((wafer or	TDO: TDO	0000 (10 (00 45 40
	33	chip or substrate or disc or disk) near2	EPO; JPO;	2003/12/22 15:48
		(storage or storing or box or holder or	DERWENT;	
		holding or housing or carrier or cartridge	IBM_TDB	
	!	or case)))) not (((surfactant or scourol)		1
		and (((wafer or chip or substrate or disc		
		or disk) near2 (storage or storing or box		
	l i	or holder or holding or housing or carrier		
		or cartridge or case))) ) and (coat\$3 or	ĺ	
	i	wash\$3 or clean\$3 or film or layer or		
		deposit\$3 or immers\$5 or submer\$6 or		
		soak\$3 or dip or dipped or dipping))		
-	178	((coat\$3 or dip or dipped or dipping or	USPAT;	2003/12/22 16:03
1 .		immers\$4 or submer\$5 or deposit\$3 or film	US-PGPUB	2003/12/22 10.03
		or layer) same ((wafer or chip or	00 10105	
		substrate or disc or disk) near3 (storage		
1		or storing or case or box or holder or		İ
	l i	holding or housing or carrier))) same	ļ	
		(surfactant or scourol)		
-	245	((coat\$3 or dip or dipped or dipping or	USPAT;	2003/12/22 15:53
1		immers\$4 or submer\$5 or deposit\$3 or film	US-PGPUB	
	j	or layer or wash\$3 or clean\$3) same		
		((wafer or chip or substrate or disc or		
		disk) near3 (storage or storing or case or		
		box or holder or holding or housing or		
		carrier))) same (surfactant or scourol)		
-	958	((coat\$3 or dip or dipped or dipping or	USPAT;	2003/12/22 16:20
		immers\$4 or submer\$5 or deposit\$3 or film	US-PGPUB	
		or layer) same ((wafer or chip or		
		substrate or disc or disk) near3 (storage		
		or storing or case or box or holder or		
		holding or housing or carrier))) same		
		(antistatic\$3 or (anti adj static\$3) or		
		((prevent\$4 or eliminat\$3 or reduc\$5 or		
		stop\$4 or lower\$3) near3 (dust or		
1_	11	contamin\$5 or particle or particulate)))		
-	11	(((coat\$3 or dip or dipped or dipping or	USPAT;	2003/12/22 16:05
1	1	immers\$4 or submer\$5 or deposit\$3 or film	US-PGPUB	
1 1		or layer) same ((wafer or chip or		
		substrate or disc or disk) near3 (storage		
!	ŀ	or storing or case or box or holder or		
] [		holding or housing or carrier))) same		
1		(antistatic\$3 or (anti adj static\$3) or ((prevent\$4 or eliminat\$3 or reduc\$5 or		
		stop\$4 or lower\$3) near3 (dust or		İ
	ļ	contamin\$5 or particle or particulate))))		
		and (((427/230,235).CCLS.)		
		((427/352,353,354).CCLS.)		
		((427/372.2,379,384).CCLS.)	i	İ
		((427/430.1).CCLS.) ((438/125).CCLS.)		
	1	((206/308.1,524.1,524.6,525,526,832).CCLS.)		
	1	((206/524.3).CCLS.))		

-	38		USPAT;	2003/12/22 16:12
	İ	immers\$4 or submer\$5 or deposit\$3 or film	US-PGPUB	1,, 13.12
		or layer) same ((wafer or chip or		
1	I	substrate or disc or disk) near3 ((storage	1	1
		or storing or holding or housing or		
		transport\$5) near2 (case or box or holder	1	
		or carrier)))) same (antistatic\$3 or (anti	1	
		adj static\$3) or ((prevent\$4 or eliminat\$3		
		or reduc\$5 or stop\$4 or lower\$3) near3		ļ
1		(dust or contamin\$5 or particle or	ĺ	
		particulate)))		
-	62		USPAT;	2003/12/22 16:19
1		immers\$4 or submer\$5 or deposit\$3 or film	US-PGPUB	
		or layer) same ((wafer or chip or		
		substrate or disc or disk) near3 ((storage		
		or storing or holding or housing or	İ	1
		transport\$5) near2 (case or box or holder		
		or carrier)))) and (surfactant)		
-	62		USPAT;	2003/12/22 16:13
		immers\$4 or submer\$5 or deposit\$3 or film	US-PGPUB	1
		or layer) same ((wafer or chip or		
		substrate or disc or disk) near3 ((storage	1	ļ
	1	or storing or holding or housing or	l	
		transport\$5) near2 (case or box or holder		
		or carrier)))) and (surfactant)) not		
		((((427/230,235).CCLS.)	l	
		((427/352,353,354).CCLs.)		
		((427/372.2,379,384).CCLS.)		
	l .	((427/430.1).CCLS.) ((438/125).CCLS.)		
		((206/308.1,524.1,524.6,525,526,832).CCLS.)		
1		((206/524.3).CCLS.)) and ((coat\$3 or		
		surfactant or dip or dipped or dipping or		
		immers\$4 or submer\$5 or deposit\$3 or film		
		or layer) with ((wafer or chip or		
		substrate or disc or disk) near2 (storage		
_	33389	or storing or box or holder or holding or		
-	33389	Mousang3oorcdipier dippedtoidgepping or	USPAT;	2003/12/22 16:31
ĺ		immers\$4 or submer\$5 or deposit\$3 or film	US-PGPUB	
_	401	or layer) with (surfactant))		
l	401	(((coat\$3 or dip or dipped or dipping or	USPAT;	2003/12/22 16:19
i		immers\$4 or submer\$5 or deposit\$3 or film	US-PGPUB	
		or layer) with (surfactant)) ) and		
}		(((427/230,235).CCLS.)		
İ	j	((427/352,353,354).CCLS.)		
	i	((427/372.2,379,384).CCLS.)		
		((427/430.1).CCLS.) ((438/125).CCLS.)		
		((206/308.1,524.1,524.6,525,526,832).CCLS.)		
_	0	((206/524.3).CCLS.))		
!	٠ ا	(((((coat\$3 or dip or dipped or dipping or	USPAT;	2003/12/22 16:22
1		immers\$4 or submer\$5 or deposit\$3 or film	US-PGPUB	
		or layer) with (surfactant)) ) and		ļ i
Į		(((427/230,235).CCLS.)		
ĺ	]	((427/352,353,354).CCLS.)		ļ
	1	((427/372.2,379,384).CCLS.)		ĺ
		((427/430.1).CCLS.) ((438/125).CCLS.)		
i	j	((206/308.1,524.1,524.6,525,526,832).CCLS.)		
		((206/524.3).CCLS.))) and ((wafer or chip		ļ
ļ	ļ	or substrate or disc or disk) near3		
	- 1	((storage or storing or holding or housing		
	1	or transport(E) (		
		or transport\$5) near2 (case or box or holder or carrier))))		

-					
	-	41		USPAT;	2003/12/22 16:22
			disk) near3 (storage or storing or case or	US-PGPUB	
			box or holder or holding or housing or		
- 1			carrier or cartridge or transports8))) and		1
- 1			((((coat\$3 or dip or dipped or dipping or		
			immers\$4 or submer\$5 or deposit\$3 or film or layer) with (surfactant)) and		
			(((427/230,235).CCLS.)		
			((427/352,353,354).CCLS.)		i
-			((427/372.2,379,384),CCLS.)		
			((427/430.1).CCLS.) ((438/125).CCLS.)	ļ	]
			((206/308.1,524.1,524.6,525,526,832).CCLS.)	1	İ
			((206/524.3).CCLS.)))		
-	-	2926		USPAT;	2003/12/22 16:32
-			disk) near3 (storage or storing or case or	US-PGPUB	
			box or holder or holding or housing or		
		1	carrier or cartridge or transport\$8))) and (((coat\$3 or dip or dipped or dipping or		
			immers\$4 or submer\$5 or deposit\$3 or film		
			or layer) with (surfactant)) )		
-	-	34	((((coat\$3 or dip or dipped or dipping or	USPAT;	2003/12/22 16:22
			immers\$4 or submer\$5 or deposit\$3 or film	US-PGPUB	2003/12/22 16:22
			or layer) with (surfactant)) ) and ((wafer		
			or chip or substrate or disc or disk)		1
			near3 ((storage or storing or holding or		
		i	housing or transport\$5) near2 (case or box		1
1 -		144	or holder or carrier))))		
		1	((coat\$3 or dip or dipped or dipping or immers\$4 or submer\$5 or deposit\$3 or film	USPAT;	2003/12/22 16:34
			or layer) with (surfactant)) same	US-PGPUB	i
			((prevent\$5 or eliminat\$3 or reduc\$5 or		
			stop\$4 or lower\$3) near3 (dust\$3 or		
			contamin\$8))		
-		7772	((coat\$3 or dip or dipped or dipping or	EPO; JPO;	2003/12/22 16:33
			1mmers\$4 or submer\$5 or deposit\$3 or film	DERWENT;	
۱_		28	or layer) near5 (surfactant))	IBM_TDB	
ļ		20	(((coat\$3 or dip or dipped or dipping or	EPO; JPO;	2003/12/22 16:32
			immers\$4 or submer\$5 or deposit\$3 or film or layer) near5 (surfactant))) and	DERWENT;	
			(((wafer or chip or substrate or disc or	IBM_TDB	
			disk) near3 (storage or storing or case or		
			box or holder or holding or housing or		
			carrier or cartridge or transport\$8)))		
-		322	((coat\$3 or dip or dipped or dipping or	EPO; JPO;	2003/12/22 16:34
			immers\$4 or submer\$5 or deposit\$3 or film	DERWENT;	
			or layer) near5 (surfactant)) and (dust\$3	IBM_TDB	
1_		296	or contamin\$8)	_	
		230	((coat\$3 deposit\$3 or film or layer) near5	EPO; JPO;	2003/12/22 16:39
1			(surfactant)) and (dust\$3 or contamin\$8)	DERWENT;	
-		55	((coat\$3 or dip or dipped or dipping or	IBM_TDB	2002/12/20 16 25
1				EPO; JPO; DERWENT;	2003/12/22 16:35
			or layer) near3 (surfactant)) and	IBM TDB	
		[	((prevent\$5 or eliminat\$3 or reduc\$5 or		İ
			stop\$4 or lower\$3) near3 (dust\$3 or		
_			contamin\$8))		
-		47	((coat\$3 deposit\$3 or film or layer) near5	EPO; JPO;	2003/12/22 16:39
	j			DERWENT;	
-	J	41	444 540 1 4 4 5	IBM_TDB	
				EPO; JPO;	2003/12/23 11:13
1				DERWENT; IBM TDB	
			dip or dipped or dipping or immers\$4 or	10M_10B	1
			submer\$5 or deposit\$3 or film or laver)	1	
			near3 (surfactant)) and ((prevent\$5 or		1
			eliminat\$3 or reduc\$5 or ston\$4 or	İ	ĺ
ш			lower\$3) near3 (dust\$3 or contamin\$8)) )		